SiJA54DP

RoHS COMPLIANT

HALOGEN

FREE

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Vishay Siliconix

N-Channel 40 V (D-S) MOSFET

| PRODU | CT SUMMARY | | |
|---------------------|------------------------------------|------------------------------------|-----------------------|
| V _{DS} (V) | R _{DS(on)} (Ω) Max. | I _D (A) ^{a, g} | Q _g (Typ.) |
| 40 | 0.00235 at V _{GS} = 10 V | 60 | 32 nC |
| 40 | 0.00320 at V _{GS} = 4.5 V | 60 | |

PowerPAK[®] SO-8L Single G Top View Bottom View

Ordering Information:

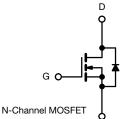
SiJA54DP-T1-GE3 (lead (Pb)-free and halogen-free)

FEATURES

- TrenchFET[®] Gen IV power MOSFET
- Tuned for the lowest R_{DS}-Q_{oss} FOM
- 100 % R_q and UIS tested
- Q_{ad} / Q_{as} ratio < 1 optimizes switching characteristics
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Synchronous rectification
- ORing
- High power density DC/DC
- VRMs and embedded DC/DC
- DC/AC inverters
- · Load switch



| ABSOLUTE MAXIMUM RATINGS (| T _A = 25 °C, unless | otherwise noted | (k | |
|--|--------------------------------|-----------------------------------|----------------------|------|
| Parameter | | Symbol | Limit | Unit |
| Drain-Source Voltage | | V _{DS} | 40 | V |
| Gate-Source Voltage | | V _{GS} | +20, -16 | V |
| | T _C = 25 °C | | 60 ^g | |
| Continuous Duoin Current (T. 150 °C) | T _C = 70 °C | | 60 g | |
| Continuous Drain Current ($T_J = 150 \ ^{\circ}C$) | T _A = 25 °C | I _D | 32.2 ^{b, c} | |
| | T _A = 70 °C | | 25.7 ^{b, c} | Α |
| Pulsed Drain Current (t = 100 µs) | · | I _{DM} | 150 | A |
| Continuous Source Drain Diada Current | T _C = 25 °C | | 33.3 | |
| Continuous Source-Drain Diode Current | T _A = 25 °C | I _S | 4 ^{b, c} | |
| Single Pulse Avalanche Current | | I _{AS} | 30 | |
| Single Pulse Avalanche Energy | L = 0.1 mH | E _{AS} | 45 | mJ |
| | T _C = 25 °C | | 36.7 | |
| Maximum Davies Diacia atian | T _C = 70 °C | P | 23.5 | w |
| Maximum Power Dissipation | T _A = 25 °C | P _D | 4.4 ^{b, c} | vv |
| | T _A = 70 °C | | 2.8 ^{b, c} | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | -55 to +150 | °C |
| Soldering Recommendations (Peak Temperature) d, e | | | 260 | -0 |

| THERMAL RESISTANCE RATINGS | 5 | | | | |
|---|--------------|-------------------|---------|---------|------|
| Parameter | | Symbol | Typical | Maximum | Unit |
| Maximum Junction-to-Ambient ^{b, f} | t ≤ 10 s | R _{thJA} | 24 | 28 | °C/W |
| Maximum Junction-to-Case (Drain) | Steady State | R _{thJC} | 2.5 | 3.4 | 0/10 |

Notes

- a. T_C = 25 °C.
- b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

- d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under steady state conditions is 70 °C/W.

g. Package limited.

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For technical questions, contact: pmostechsupport@vishay.com

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SiJA54DP

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| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit |
|---|-------------------------|--|------|---------|---------|-------|
| Static | | | | • | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 V, I_{D} = 250 \mu A$ | 40 | - | - | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_J$ | L 050 A | - | 24 | - | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = 250 μA | - | -5.2 | - | mV/°(|
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \ \mu A$ | 1.1 | - | 2.4 | V |
| Gate-Source Leakage | I _{GSS} | V _{DS} = 0 V, V _{GS} = +20 V, -16 V | - | - | ± 100 | nA |
| 7 | | $V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$ | - | - | 1 | |
| Zero Gate Voltage Drain Current | IDSS | $V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$ | - | - | 10 | μA |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$ | 30 | - | - | А |
| | _ ` ` | V _{GS} = 10 V, I _D = 15 A | - | 0.00195 | 0.00235 | - |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = 4.5 V, I _D = 10 A | | | 0.00320 | Ω |
| Forward Transconductance ^a | g _{fs} | V _{DS} = 10 V, I _D = 15 A | - | 106 | - | S |
| Dynamic ^b | | | | | 1 1 | |
| Input Capacitance | Ciss | | - | 5300 | - | |
| Output Capacitance | C _{oss} | V _{DS} = 20 V, V _{GS} = 0 V, f = 1 MHz | - | 707 | - | pF |
| Reverse Transfer Capacitance | C _{rss} | | - | 105 | - | |
| | Qg | $V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$ | - | 69 | 104 | nC |
| Total Gate Charge | | | - | 32 | 48 | |
| Gate-Source Charge | Q _{gs} | $V_{DS} = 20 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$ | - | 13.5 | - | |
| Gate-Drain Charge | Q _{ad} | | - | 6.9 | - | |
| Output Charge | Q _{oss} | $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$ | - | 30.5 | 46 | |
| Gate Resistance | Rg | f = 1 MHz | 0.4 | 1.1 | 2.0 | Ω |
| Turn-On Delay Time | t _{d(on)} | | - | 8 | 16 | |
| Rise Time | t _r | $V_{DD} = 20 V, R_1 = 2 \Omega$ | - | 8 | 16 | |
| Turn-Off Delay Time | t _{d(off)} | $I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$ | - | 28 | 56 | |
| Fall Time | t _f | | - | 7 | 14 | |
| Turn-On Delay Time | t _{d(on)} | | - | 24 | 48 | ns |
| Rise Time | t _r | $V_{DD} = 20 V, R_1 = 2 \Omega$ | - | 69 | 138 | |
| Turn-Off Delay Time | t _{d(off)} | $I_D \cong 10 \text{ A}, V_{\text{GEN}} = 4.5 \text{ V}, R_g = 1 \Omega$ | - | 23 | 46 | |
| Fall Time | t _f | | - | 10 | 20 | |
| Drain-Source Body Diode Characteristic | S | | | - | 1 1 | |
| Continuous Source-Drain Diode Current | ا _s | T _C = 25 °C | - | - | 33.3 | |
| Pulse Diode Forward Current (t = 100 µs) | I _{SM} | - | - | - 1 | 150 | A |
| Body Diode Voltage | V _{SD} | I _S = 5 A | - | 0.72 | 1.1 | V |
| Body Diode Reverse Recovery Time | t _{rr} | - | - | 44 | 88 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | | - | 58 | 116 | nC |
| Reverse Recovery Fall Time | ta | I _F = 10 A, dl/dt = 100 A/μs, T _J = 25 °C | - | 29 | - | |
| Reverse Recovery Rise Time | t _b | | - | 15 | | ns |

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

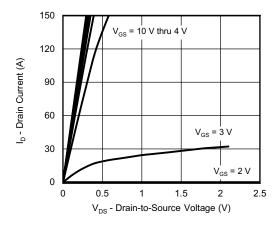
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

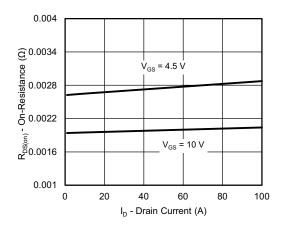
2



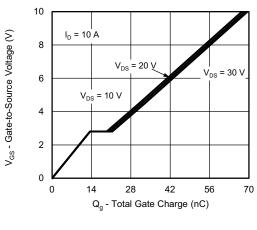
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



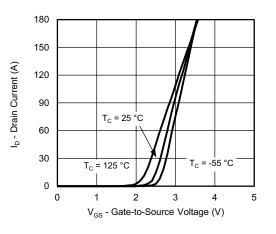
Output Characteristics



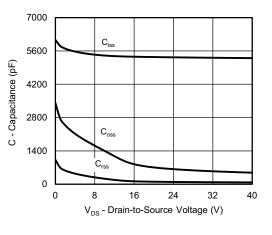
On-Resistance vs. Drain Current



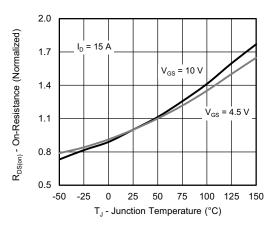
Gate Charge



Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

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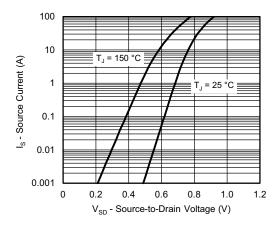
3

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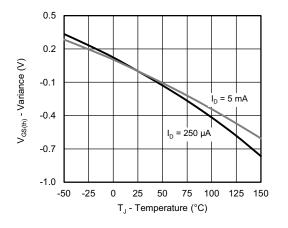
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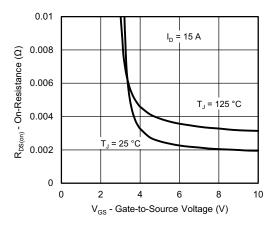
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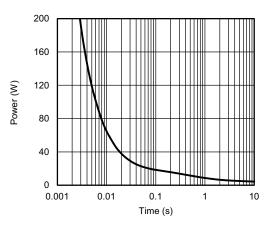
Source-Drain Diode Forward Voltage



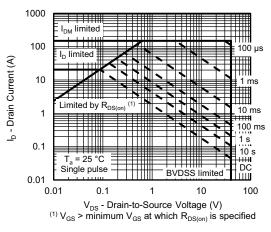
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

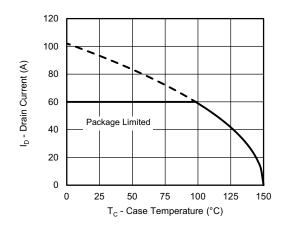
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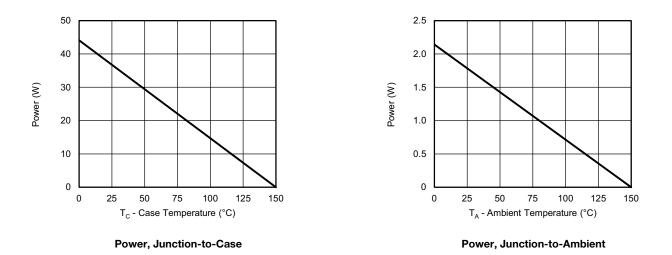
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







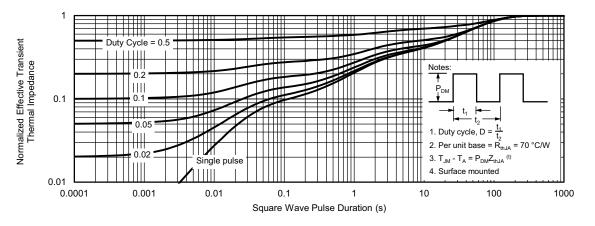
Note

a. The power dissipation P_D is based on T_J (max.) = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

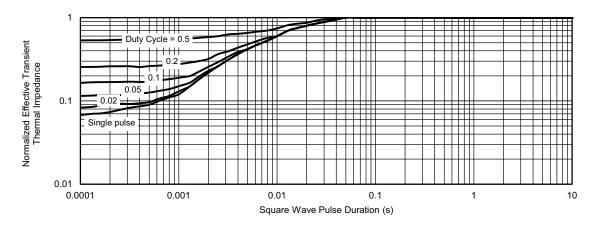
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



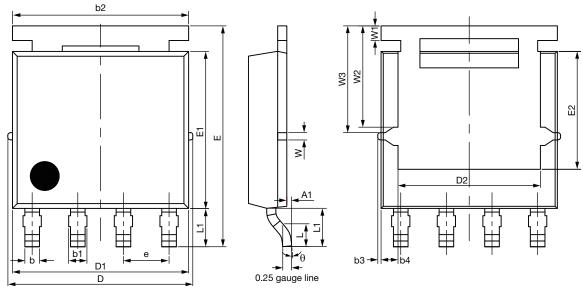
Normalized Thermal Transient Impedance, Junction-to-Case

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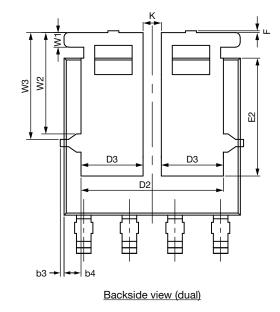


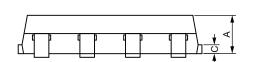




Topside view

Backside view (single)





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Package Information



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| 514 | | MILLIMETERS | | | INCHES | | | |
|------|------|-------------|-------|-----------|--------|-------|--|--|
| DIM. | MIN. | NOM. | MAX. | MIN. | NOM. | MAX. | | |
| А | 1.00 | 1.07 | 1.14 | 0.039 | 0.042 | 0.045 | | |
| A1 | 0.00 | - | 0.127 | 0.00 | - | 0.005 | | |
| b | 0.33 | 0.41 | 0.48 | 0.013 | 0.016 | 0.019 | | |
| b1 | 0.44 | 0.51 | 0.58 | 0.017 | 0.020 | 0.023 | | |
| b2 | 4.80 | 4.90 | 5.00 | 0.189 | 0.193 | 0.197 | | |
| b3 | | 0.094 | | | 0.004 | | | |
| b4 | | 0.47 | | | 0.019 | | | |
| С | 0.20 | 0.25 | 0.30 | 0.008 | 0.010 | 0.012 | | |
| D | 5.00 | 5.13 | 5.25 | 0.197 | 0.202 | 0.207 | | |
| D1 | 4.80 | 4.90 | 5.00 | 0.189 | 0.193 | 0.197 | | |
| D2 | 3.86 | 3.96 | 4.06 | 0.152 | 0.156 | 0.160 | | |
| D3 | 1.63 | 1.73 | 1.83 | 0.064 | 0.068 | 0.072 | | |
| е | | 1.27 BSC | | 0.050 BSC | | | | |
| E | 6.05 | 6.15 | 6.25 | 0.238 | 0.242 | 0.246 | | |
| E1 | 4.27 | 4.37 | 4.47 | 0.168 | 0.172 | 0.176 | | |
| E2 | 3.18 | 3.28 | 3.38 | 0.125 | 0.129 | 0.133 | | |
| F | - | - | 0.15 | - | - | 0.006 | | |
| L | 0.62 | 0.72 | 0.82 | 0.024 | 0.028 | 0.032 | | |
| L1 | 0.92 | 1.07 | 1.22 | 0.036 | 0.042 | 0.048 | | |
| К | | 0.51 | | | 0.020 | | | |
| W | | 0.23 | | | 0.009 | | | |
| W1 | 0.41 | | | 0.016 | | | | |
| W2 | 2.82 | | | 0.111 | | | | |
| W3 | | 2.96 | | | 0.117 | | | |
| θ | 0° | - | 10° | 0° | - | 10° | | |

Note

• Millimeters will gover



RECOMMENDED MINIMUM PAD FOR PowerPAK[®] SO-8L SINGLE



Recommended Minimum Pads Dimensions in mm (inches)

Revision: 07-Feb-12



Vishay

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